

High Efficiency, Up to 33V, 4A Peak, 1.0MHz, DC-DC Boost(Step-Up) Regulator

PRELIMINARY DATASHEET

General Description

The FH47304 is a high efficiency, current-mode control boost regulator. The device integrates a $120\,\mathrm{m}\Omega$ low $R_{\mathrm{DS(ON)}}$ N-channel MOSFET for high efficiency. The fixed 1.0MHz switching frequency and internal compensation reduce external components size and count. The build-in internal soft start circuitry minimizes the inrush current at start-up.

The FH47304 is available in compact DFN3*3-10L package.



Features

Wide input range: 3.0 ~ 33.0V
Maximum output voltage: 33.0V

• Switching frequency: 1.0MHz

 Integrated 120 mΩ R_{DS(ON)} switch with 4.0A peak current capability

• Internal soft-start

Reference voltage: 0.6V(±2%)
Cycle by cycle peak current limit

• Over temperature protection

RoHs Compliant and Halogen Free

• Compact package: DFN3*3-10L

Applications

• Portable Device

• Battery Powered System

 Networking cards powered from PCI or PCI-express slots

Typical Applications

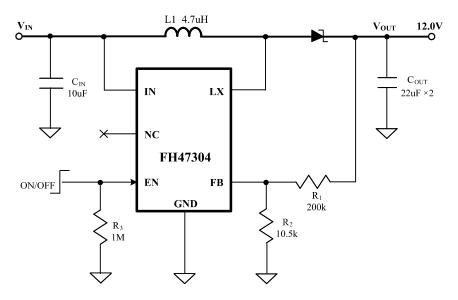


Figure 1. FH47304 Schematic Diagram

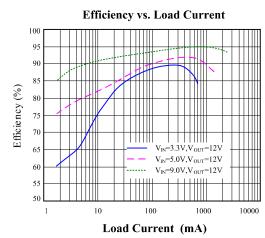
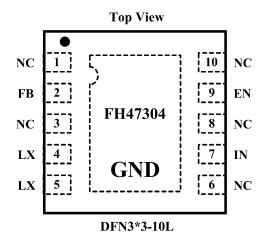


Figure 2. Efficiency vs. Load Current



PIN Configuration

PRELIMINARY DATASHEET



PIN Description

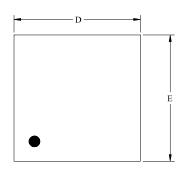
Pin Name	Pin Number	Pin Description				
IN	7	Input pin. Decouple this pin to GND pin with 1uF ceramic cap.				
GND	11	Ground pin				
LX	4,5	Inductor node. Connect an inductor between IN pin and LX pin.				
FB	2	Feedback pin. Connect a resistor R1 between V_{OUT} and FB, and a resistor R2 between FB and GND to program the output voltage: V_{OUT} =0.6V*(R1/R2+1).				
EN	9	Enable control. High to turn on the part. Don't leave it floated.				
NC	1,3,6,8,10	No connection.				



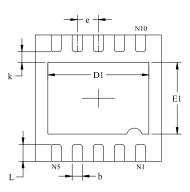
Package Outline

PRELIMINARY DATASHEET

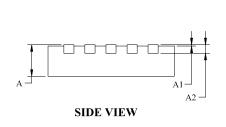
DFN3*3-10L

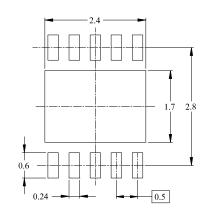


TOP VIEW



BOTTOM VIEW





RECOMMENDED LAND PATTERN (Unit: mm)

Symbol	Dimer In Mill	nsions imeters	Dimensions In Inches		
	MIN	MAX	MIN	MAX	
A	0.700	0.800	0.028	0.031	
A1	0.000	0.050	0.000	0.002	
A2	0.203 REF		0.008 REF		
D	2.900	3.100	0.114	0.122	
D1	2.300	2.600	0.091	0.103	
Е	2.900	3.100	0.114	0.122	
E1	1.500	1.800	0.059	0.071	
k	0.200) MIN	0.008 MIN		
b	0.180	0.300	0.007	0.012	
e	0.500	TYP	0.020 TYP		
L	0.300	0.500	0.012	0.020	



Ordering Information

PRELIMINARY DATASHEET

Part Number	Voltage Range	Features	Operating Temperature	Package Type	Top Mark	SPQ
FH47304D10	3.0V ~ 33.0V	 DC-DC boost(step-up) Peak current: 4.0A Efficiency: 95% Output voltage: ~33.0V Switch Frequency: 1.0MHz FB voltage: 0.6V(±2%) 	-40°C to 85°C	DFN3*3-10L	VI <u>YY MM LL</u>	5000PCS/Reel

Note:

- FH47304 devices are Pb-free and RoHs compliant.
- > The surface prints of our semiconductor devices are subject to change during the production process and do not involve changes in electrical parameters, and we will not separately state the notice.
- > If you have any other custom purchase needs, please contact our sales department.
- > ForDevices reserves the right to amend and legally interpret the electrical parameters of this chip device. (http://www.fordevices.com)

Device Name: DFN3*3-10L





ESD SENSITIVITY CAUTION

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.























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▲ Update by Jan.2022